

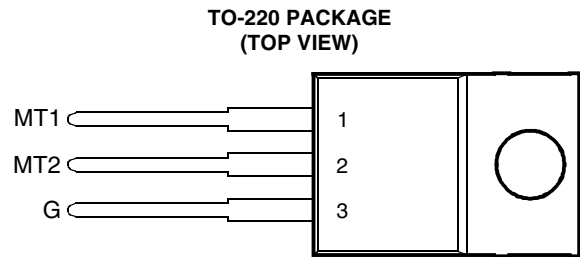
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- Sensitive Gate Triacs
- 8 A RMS, 70 A Peak
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- Max I_{GT} of 5 mA (Quadrant 1)



Pin 2 is in electrical contact with the mounting base.

MDC2ACA

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Repetitive peak off-state voltage (see Note 1)	TIC225D	V_{DRM}	400	V
	TIC225M		600	
	TIC225S		700	
	TIC225N		800	
Full-cycle RMS on-state current at (or below) 70°C case temperature (see Note 2)		$I_{T(RMS)}$	8	A
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)		I_{TSM}	70	A
Peak gate current		I_{GM}	±1	A
Peak gate power dissipation at (or below) 85°C case temperature (pulse width ≤ 200 μs)		P_{GM}	2.2	W
Average gate power dissipation at (or below) 85°C case temperature (see Note 4)		$P_{G(AV)}$	0.9	W
Operating case temperature range		T_C	-40 to +110	°C
Storage temperature range		T_{stg}	-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds		T_L	230	°C

- NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.
 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 200 mA/°C.
 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
 4. This value applies for a maximum averaging time of 20 ms.

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
I_{DRM}	Repetitive peak off-state current	$V_D = \text{rated } V_{DRM}$	$I_G = 0$	$T_C = 110^\circ\text{C}$			±2	mA
I_{GT}	Gate trigger current	$V_{supply} = +12\text{ V}^\dagger$	$R_L = 10\ \Omega$	$t_{p(g)} > 20\ \mu\text{s}$		2.3	5	mA
		$V_{supply} = +12\text{ V}^\dagger$	$R_L = 10\ \Omega$	$t_{p(g)} > 20\ \mu\text{s}$		-3.8	-20	
		$V_{supply} = -12\text{ V}^\dagger$	$R_L = 10\ \Omega$	$t_{p(g)} > 20\ \mu\text{s}$		-3	-10	
		$V_{supply} = -12\text{ V}^\dagger$	$R_L = 10\ \Omega$	$t_{p(g)} > 20\ \mu\text{s}$		6	30	

† All voltages are with respect to Main Terminal 1.

PRODUCT INFORMATION

electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V_{GT}	Gate trigger voltage	$V_{supply} = +12 V†$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		0.7	2	V
		$V_{supply} = +12 V†$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		-0.7	-2	
		$V_{supply} = -12 V†$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		-0.7	-2	
		$V_{supply} = -12 V†$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu s$		0.8	2	
V_T	On-state voltage	$I_T = \pm 12 A$	$I_G = 50 mA$	(see Note 5)		± 1.5	± 2.1	V
I_H	Holding current	$V_{supply} = +12 V†$	$I_G = 0$	Init' $I_T = 100 mA$		2.3	20	mA
		$V_{supply} = -12 V†$	$I_G = 0$	Init' $I_T = -100 mA$		-1.6	-20	
I_L	Latching current	$V_{supply} = +12 V†$	(see Note 6)				30	mA
		$V_{supply} = -12 V†$					-30	
dv/dt	Critical rate of rise of off-state voltage	$V_{DRM} = \text{Rated } V_{DRM}$	$I_G = 0$	$T_C = 110^\circ C$		± 20		V/ μs
dv/dt _(c)	Critical rise of commutation voltage	$V_{DRM} = \text{Rated } V_{DRM}$	$I_{TRM} = \pm 12 A$	$T_C = 70^\circ C$ (see Figure 6)	± 1	± 4.5		V/ μs

† All voltages are with respect to Main Terminal 1.

NOTES: 5. This parameter must be measured using pulse techniques, $t_p = \leq 1 ms$, duty cycle $\leq 2 \%$. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

6. The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics:
 $R_G = 100 \Omega$, $t_{p(g)} = 20 \mu s$, $t_r = \leq 15 ns$, $f = 1 kHz$

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.5	$^\circ C/W$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ C/W$

OBSOLETE

TYPICAL CHARACTERISTICS

GATE TRIGGER CURRENT
vs

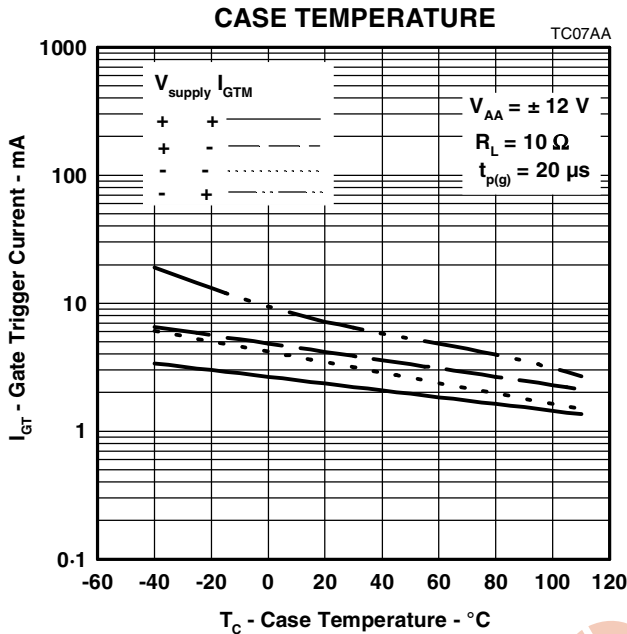


Figure 1.

GATE TRIGGER VOLTAGE
vs

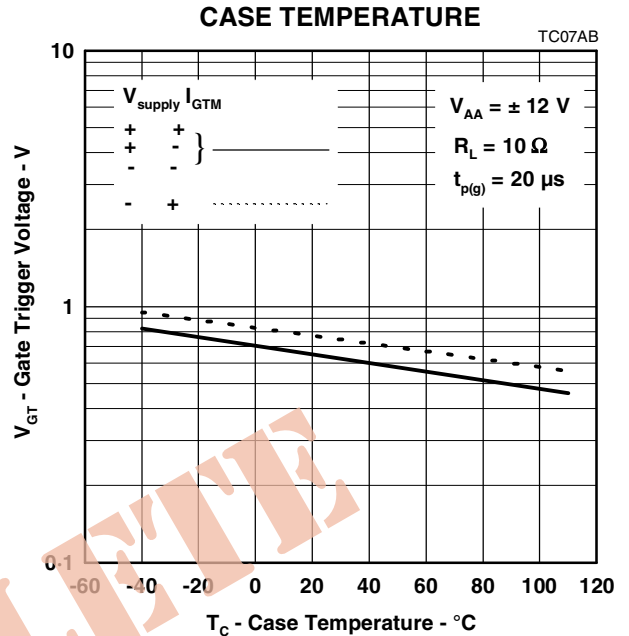


Figure 2.

HOLDING CURRENT
vs
CASE TEMPERATURE

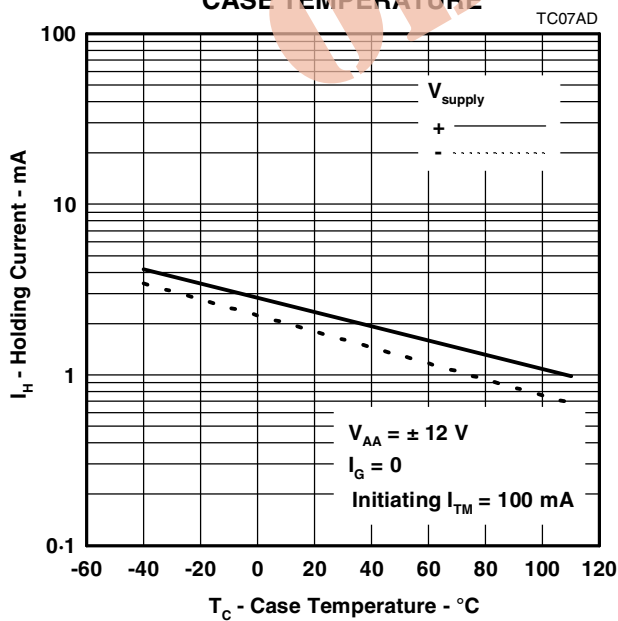


Figure 3.

LATCHING CURRENT
vs
CASE TEMPERATURE

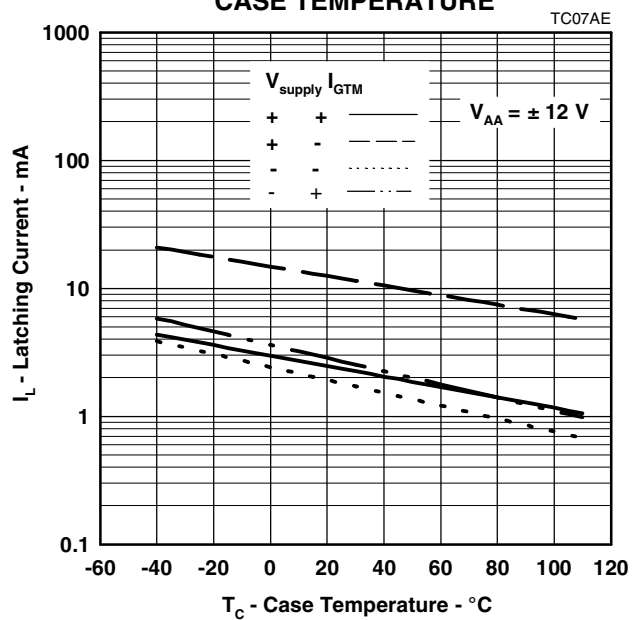


Figure 4.

PRODUCT INFORMATION

THERMAL INFORMATION

**MAXIMUM RMS ON-STATE CURRENT
VS**

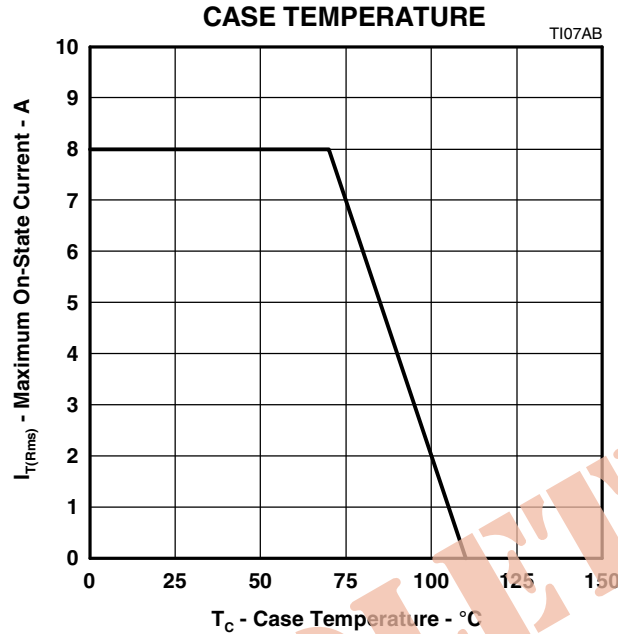
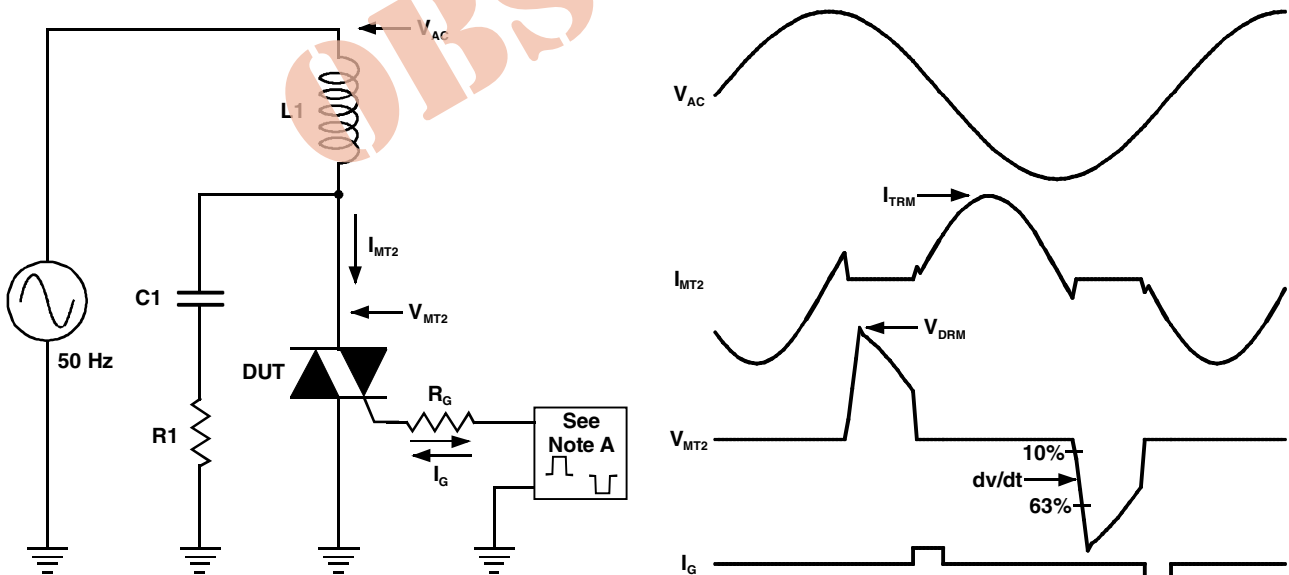


Figure 5.

PARAMETER MEASUREMENT INFORMATION



NOTE A: The gate-current pulse is furnished by a trigger circuit which presents essentially an open circuit between pulses. The pulse is timed so that the off-state-voltage duration is approximately 800 μ s.

PMC2AA

Figure 6.

PRODUCT INFORMATION

JULY 1975 - REVISED SEPTEMBER 2002
Specifications are subject to change without notice.